MA2J7320G

Silicon epitaxial planar type

For switching

For wave detection

■ Features

- Low forward voltage V_F, optimum for low voltage rectification
- Low V_F type of MA3X704A
- Optimum for high frequency rectification because of its short reverse recovery time t_{rr}

Package

- Code
 SMini2-F3
- Pin Name
 - 1: Anode
 - 2: Cathode

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V_R	30	V	
Maximum peak reverse voltage	V _{RM}	30	V	
Forward current	I_{F}	30	mA	
Peak forward current	I_{FM}	150	mA	
Junction temperature	T _j	125	°C	
Storage temperature	T _{stg}	-55 to +125	°C	

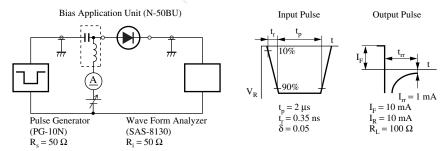
■ Marking Symbol: 2C

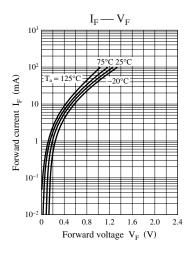
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

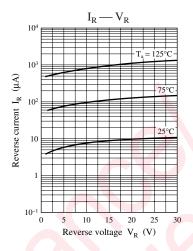
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _{F1}	$I_F = 1 \text{ mA}$	2 1/2	0,0	0.3	V
	V_{F2}	$I_F = 30 \text{ mA}$	000	0///	1.0	
Reverse current	I_R	$V_R = 30 \text{ V}$	D	5-7	30	μΑ
Terminal capacitance	C_{t}	$V_R = 1 \text{ V, f} = 1 \text{ MHz}$	0,0,	1.5		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 10 \text{ mA}$		1.0		ns
		$I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$				
Detection efficiency	η	$V_{IN} = 3 V_{(peak)}$, $f = 30 MHz$		65		%
		$R_L = 3.9 \text{ k}\Omega, C_L = 10 \text{ pF}$				

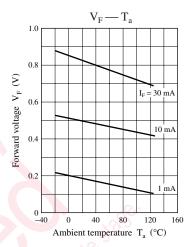
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 2 GHz.

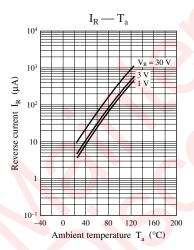
4. *: t_{rr} measurement circuit

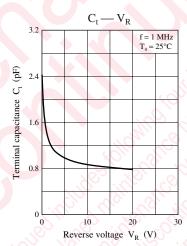


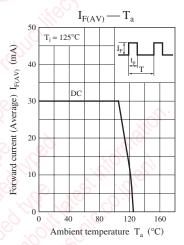






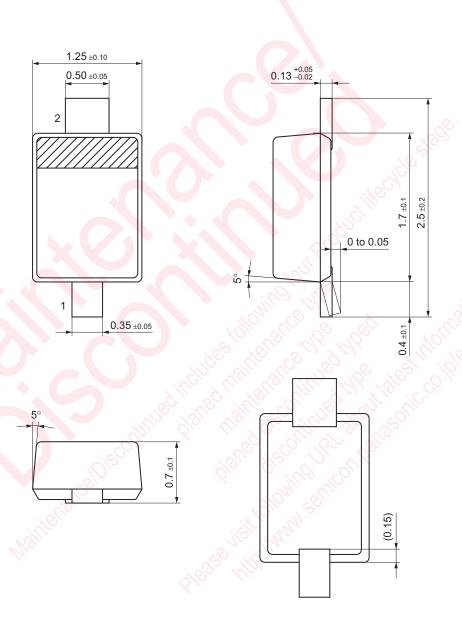






2 SKH00173AED

SMini2-F3 Unit: mm



SKH00173AED 3

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